ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	terial Composition pyright 2005. IPC, Banational and Pan-Amer	n Declaration nnockburn, Illinois. A ican copyright conve	All rights reserved untions.	inder both	This docume level parts, tl	ent is a declaration he declaration en	on of the substance acompasses all lo	es within the man wer level material	ufacturer liste s for which the	d item. Note: i e manufacturer	f the item is an as r has engineering	ssembly with lowe responsibility.	
757-71				Form Type Distribute					Materials and	rials and Mfg Information			
Supplier Information													
Company name*	Company un	Company unique ID			Unique ID Authority				Response Date*				
onsemi									2025-06-06				
Contact Name	Title - Conta	Title - Contact			Phone - Contact*				Email - Contact*				
Product-Env-Stewards	Product Env	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*	Title - Repre	Title - Representative			Phone - Representative*			Emai	Email - Representative*				
Product-Env-Stewards	Product Env	Product Enviro Compliance			NA			Prod	Product-Env-Stewards@onsemi.com				
Requester Item N	Requester Item Number Mfr Iter		n Number Mfr Item Name			Effective Date	Version	Manufacturing	Site	Weight*	UOM	Unit Type	
	F	FCH023N65S3-F155 SF3 650V 2		23mOhm E TO247L		2025-06-06		CNP		5456.925	mg	Each	
Manufacturing Procee	ess Information							<u>.</u>				1	
Terminal Plating	Terminal Plating / Grid Array Material		Ferminal Base Alloy J-STD-020 M		Rating	Peak Process Body Temperatu		ture Max Time a	at Peak Tempe	erature Numb	per of Reflow Cyc	cles	
Matte Tin (Sn) - annealed		CU Alloy	CU Alloy NA			0	С	30	sec	conds 3			
comments													
or more information rega	rding material compo	sition please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company that agreement, will be the sole and exclusive	ase indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, mium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part tains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall sompass all such components.Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, of the date that Supplier completes this form.Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. mpany acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not ependently verified information provided by others, Supplier agrees that, at a minimum, itssuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the tification in this paragraph.If the Company and the Supplier into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of t agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the ab									
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).							
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the					
Supplier Digital Signature	astislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	32.0	mg	Supplier	Silicon (Si)	7440-21-3		32	mg
Die Attach Solder	35.025	mg	Supplier	Silver (Ag)	7440-22-4		0.8756	mg
			А	Lead (Pb)	7439-92-1	7a	32.3981	mg
			Supplier	Tin (Sn)	7440-31-5		1.7512	mg
Lead Frame	3612.9	mg	Supplier	Iron (Fe)	7439-89-6		3.6129	mg
			Supplier	Copper (Cu)	7440-50-8		3608.2031	mg
			Supplier	Phosphorus (P)	7723-14-0		1.0839	mg
Mold Compound-Black	1740.0	mg	Supplier	Polymer(phenyl glycidil ether)-co- dicyclopentadiene	119345-05-0		87	mg
			Supplier	Proprietary	Proprietary Data		87	mg
			Supplier	Carbon Black (C)	1333-86-4		8.7	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		78.3	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1305	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		87	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		87	mg
Plating	31.0	mg	Supplier	Tin (Sn)	7440-31-5		31	mg
Wire Bond - Al	6.0	mg	Supplier	Aluminum (Al)	7429-90-5		6	mg